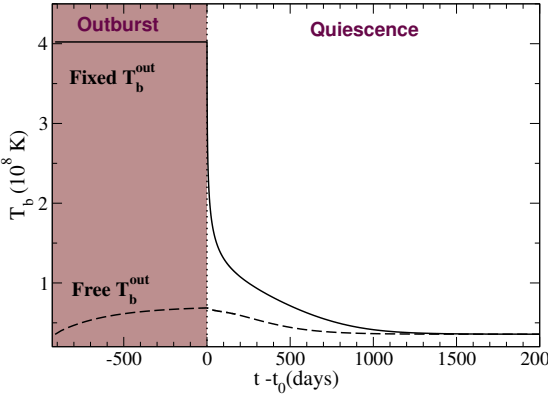
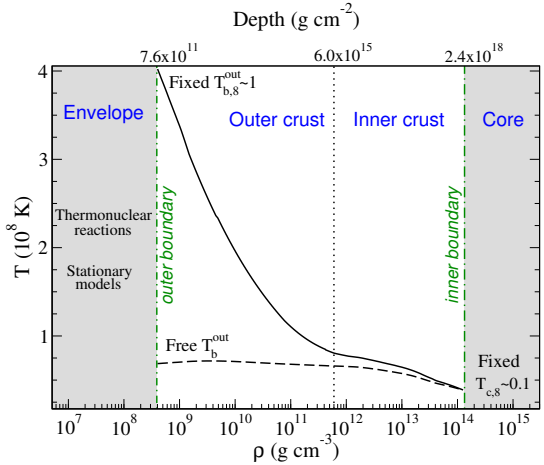
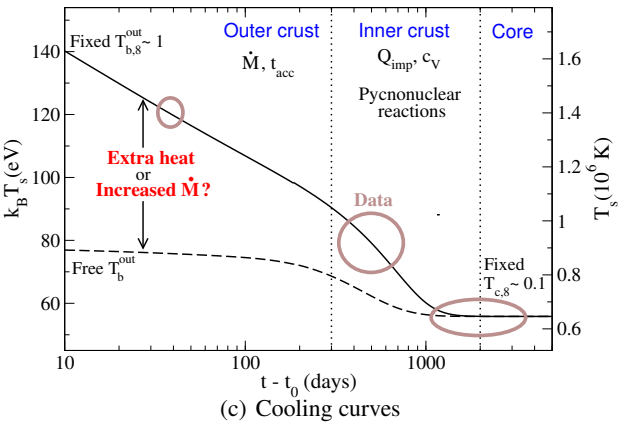


(a) Temperatures at the crust-envelope interface



(b) Initial thermal profiles ($t = t_0$)



(c) Cooling curves